

Document ID	https://docs.google.com/document/d/1DEs5B8fTGEObqthepHxeRTA/c4-JtRfM6PydsHGzJ3c/edit
Responsible	Maaïke Taklo
Classification	Confidential

Revision History Table

Named revision	Date	Comment:
01	2019-07-08	First version shared with UL
02	2019-07-26	Split document for CCON and sensor, here sensor
03	2019-10-17	Sharper internal photo of sensor and antenna indicated with arrows

8) Internal Photos

Instructions: "Clear sharp focused views of the internals of the device including close up shots of all PCBs (top and bottom, with and without RF shields). It must be possible to identify individual components on PCBs. The photos must be clear and Photos must be taken vertically straight down not angled. All photos are to be placed in a single PDFed exhibit"

Sensor US

Pictures of part 100544 DT Node0, Array, US

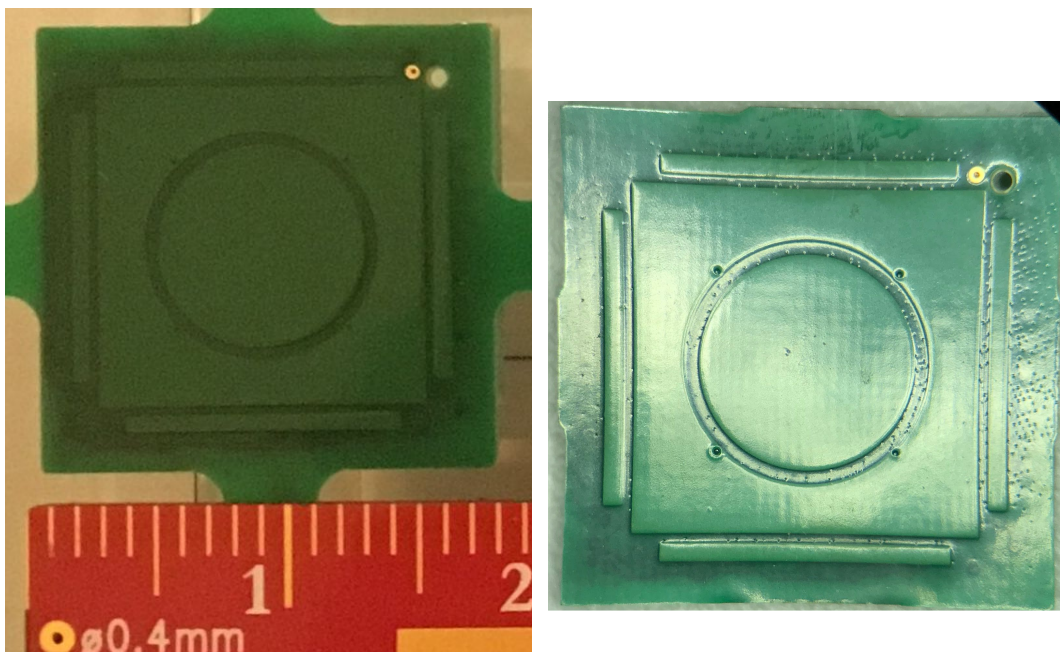


Figure 1: Picture of **top** of part 100544 DT Node0, Array, US; dimensions are included in the picture to the left whereas details are better seen in the picture to the right.

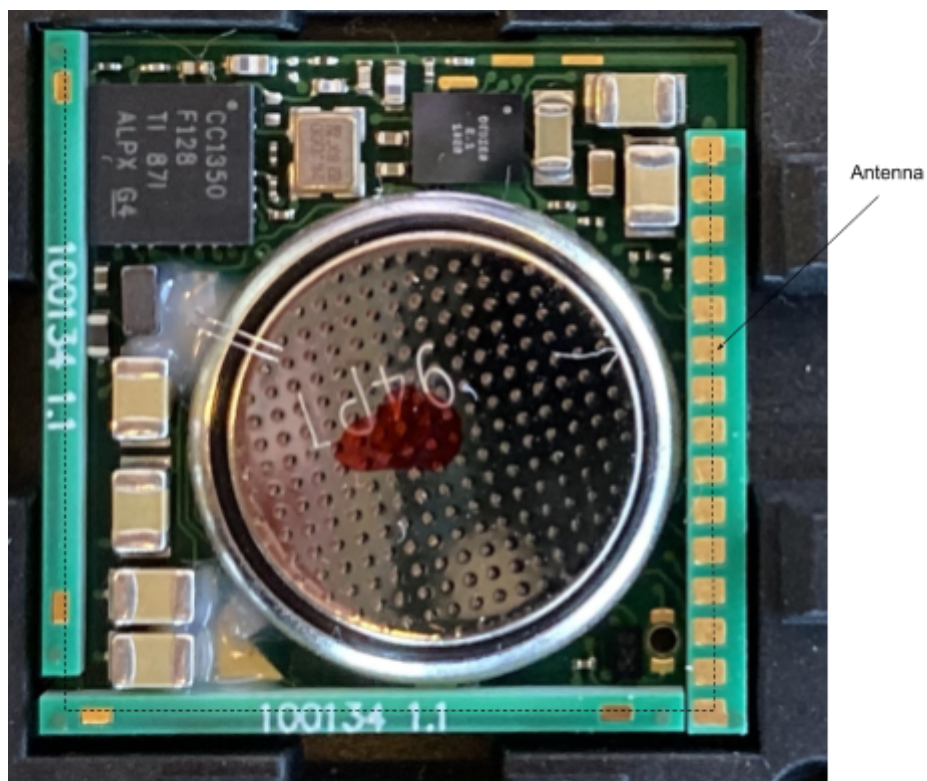
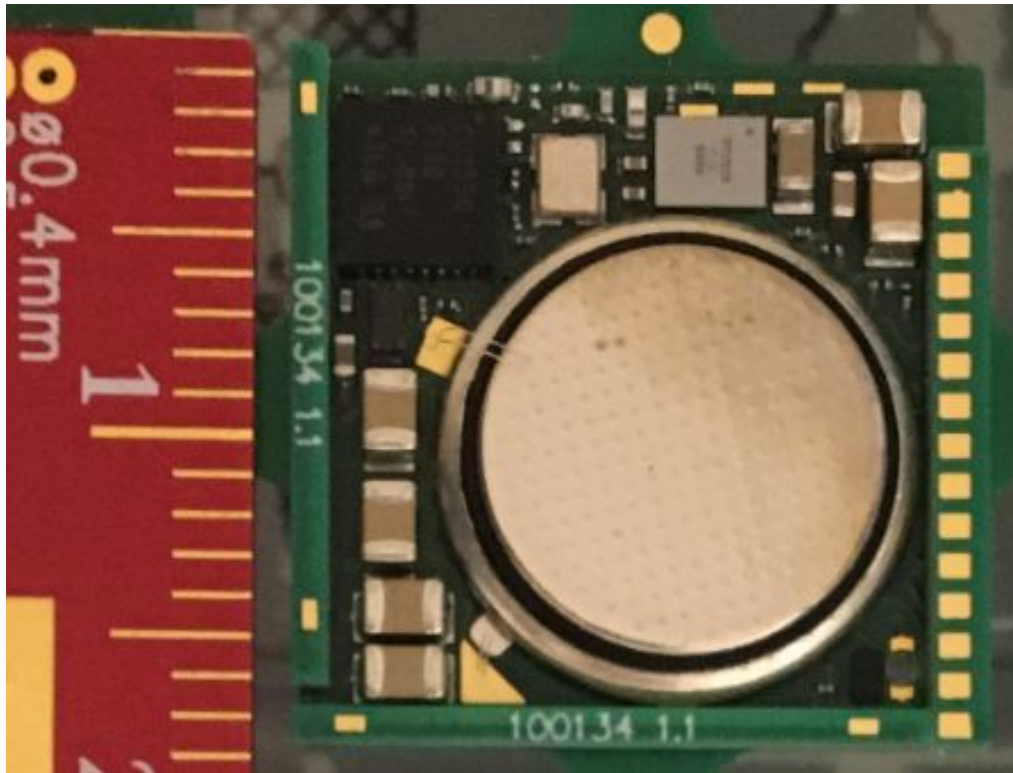


Figure 2: Two pictures of the **bottom** of part 100544 DT Node0, Array, US. Dimensions are illustrated in the uppermost picture whereas more details and the antenna location are seen in the lowermost picture.